



Click here for the 3D model.

Dimensions	
L	5.9mm +/-0.75mm
W	5mm +/-0.4mm
т	5.1mm +/-0.4mm
В	0.7mm +/-0.35mm

Packaging Specifications				
Packaging	T&R, 330mm, Plastic Tape			
Packaging Quantity	1250			

General Information	
Series	KONNEKT Comm X7R
Style	KONNEKT
Description	SMD, MLCC, KONNEKT, Ultra-Stable, Class II
Features	High Density Packaging
RoHS	Yes
Termination	Flexible Termination
AEC-Q200	No
Component Weight	790 mg
Chip Size	2220-2
Shelf Life	78 Weeks
MSL	1

Specifications			
Capacitance	0.16 uF		
Measurement Condition	120 Hz 0.5Vrms		
Capacitance Tolerance	20%		
Voltage DC	1500 VDC		
Dielectric Withstanding Voltage	1800 VDC		
Temperature Range	-55/+125°C		
Temperature Coefficient	X7R		
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 120Hz 0.5Vrms		
Dissipation Factor	2.5% 120 Hz 0.5Vrms		
Aging Rate	3% Loss/Decade Hour		
Insulation Resistance	6.25 GOhms		

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